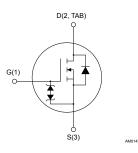


# N-channel 600 V, 60 m $\Omega$ typ., 42 A MDmesh M2 Power MOSFET in a TO-247 package

# 3

TO-247



#### **Features**

Order code	V DS @ T <sub>Jmax</sub> .	R <sub>DS(on)</sub> max.	I <sub>D</sub>
STW48N60M2	650 V	70 mΩ	42 A

- Extremely low gate charge
- Excellent output capacitance (C<sub>OSS</sub>) profile
- 100% avalanche tested
- Zener-protected

#### **Applications**

· Switching applications

#### **Description**

This device is an N-channel Power MOSFET developed using MDmesh M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.



Product status	
STW48N60M2	

Device summary			
Order code STW48N60M2			
Marking	48N60M2		
Package	TO-247		
Packing	Tube		



# 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate-source voltage	±25	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	42	А
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	26	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)		А
P <sub>TOT</sub>	Total power dissipation at T <sub>C</sub> = 25 °C	300	W
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
T <sub>stg</sub>	Storage temperature range	- 55 to 150	°C
Tj	Operating junction temperature range	- 55 to 150	C

- 1. Pulse width limited by safe operating area.
- 2.  $I_{SD} \le 42$  A,  $di/dt \le 400$  A/ $\mu s$ ;  $V_{DS(peak)} < V_{(BR)DSS}$ ,  $V_{DD} = 400$  V
- $3. \quad V_{DS} \leq 480 \ V$

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	0.42	°C/W
R <sub>thj-amb</sub>	R <sub>thj-amb</sub> Thermal resistance junction-ambient		°C/W

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive $(\text{pulse width limited by } T_{j\text{max.}})$		А
E <sub>AS</sub>	E <sub>AS</sub> Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ ; $V_{DD} = 50$ V)		J

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# 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Table 4. On /off-states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	600			V
la a a	Zero-gate voltage	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 600 V			1	μΑ
I <sub>DSS</sub>	drain current	$V_{GS}$ = 0 V, $V_{DS}$ = 600 V, $T_{C}$ = 125 °C <sup>(1)</sup>			100	μA
I <sub>GSS</sub>	Gate-body leakage current	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±25 V			±10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	3	4	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 21 A		60	70	mΩ

<sup>1.</sup> Defined by design, not subject to production test.

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	3060	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V, f = 1 MHz	-	143	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	4.3	-	pF
C oss eq. (1)	Equivalent output capacitance	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 0 to 480 V	-	630	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz, I <sub>D</sub> = 0 A	-	4.6	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 42 A,	-	70	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 0 to 10 V	-	10.5	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 14. Test circuit for gate charge behavior )	-	31	-	nC

<sup>1.</sup>  $C_{\text{oss eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{\text{oss}}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

**Table 6. Switching times** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d (on)</sub>	Turn-on delay time	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 21 A,	-	18.5	-	ns
t <sub>r</sub>	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 13. Test circuit for resistive load switching times and Figure 18. Switching time	-	17	-	ns
t <sub>d(off)</sub>	Turn-off delay time		-	119	-	ns
t <sub>f</sub>	Fall time	waveform)	-	13	-	ns

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Table 7. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		42	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		168	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 21 A	-		1.6	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 42 A, di/dt = 100 A/μs V <sub>DD</sub> = 60 V (see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	487		ns
Q <sub>rr</sub>	Reverse recovery charge		-	9.1		μC
I <sub>RRM</sub>	Reverse recovery current		-	37.5		Α
t <sub>rr</sub>	Reverse recovery time	$I_{SD}$ = 42 A, di/dt = 100 A/ $\mu$ s $V_{DD}$ = 60 V, $T_j$ = 150 °C (see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	605		ns
Q <sub>rr</sub>	Reverse recovery charge		-	12.5		μC
I <sub>RRM</sub>	Reverse recovery current		-	41.5		Α

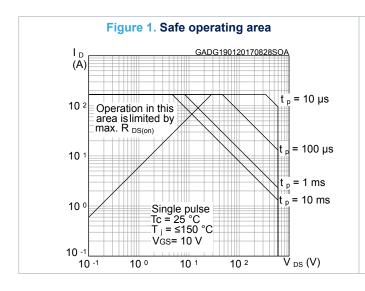
<sup>1.</sup> Pulse width limited by safe operating area.

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<sup>2.</sup> Pulsed: pulse duration =  $300 \mu s$ , duty cycle 1.5%.



#### 2.1 Electrical characteristics (curves)



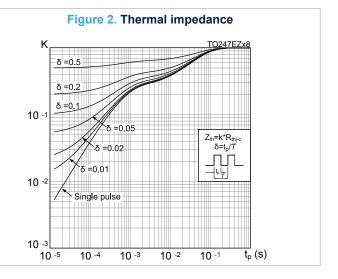
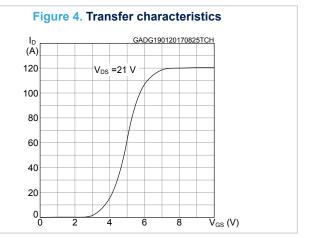
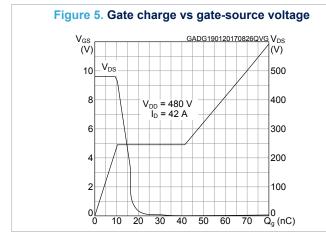
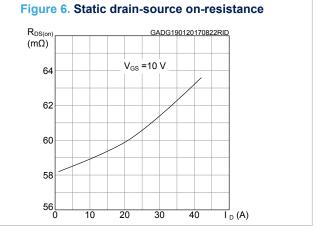


Figure 3. Output characteristics I<sub>D</sub> (A) GADG190120170825OCH  $V_{GS} = 8, 9, 10 V$ 120 7 V 100 6 V 80 60 5 V 40 20 4 V 20  $\vec{V}_{DS}(V)$ 







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Figure 7. Capacitance variations

C
(pF)

10 4

10 2

Coss

Coss

Coss

10 1

Coss

E OSS (µJ) 20 GADG190120170827EOS (ADG190120170827EOS (BADG190120170827EOS (ADG190120170827EOS (ADG19012017082FEOS (ADG1901201

temperature

V<sub>GS(th)</sub>
(norm.)

1.1

1.0

0.9

0.8

0.7

0.6

-75

-25

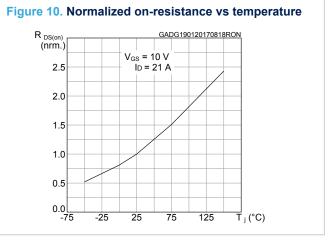
25

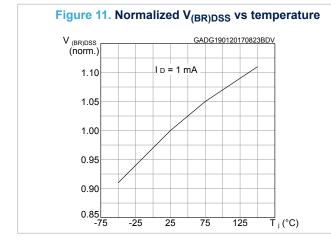
75

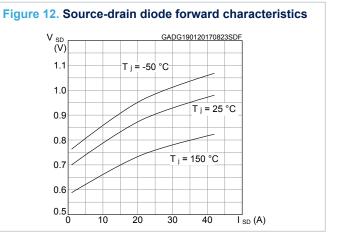
125

T<sub>j</sub> (°C)

Figure 9. Normalized gate threshold voltage vs







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# 3 Test circuits

Figure 13. Test circuit for resistive load switching times

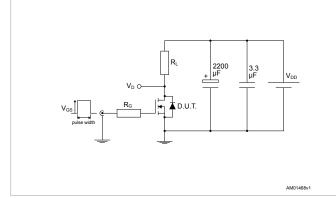


Figure 14. Test circuit for gate charge behavior

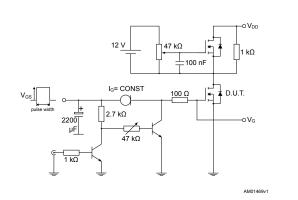


Figure 15. Test circuit for inductive load switching and diode recovery times

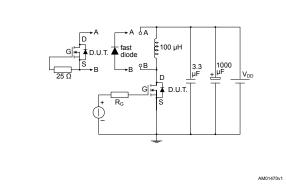


Figure 16. Unclamped inductive load test circuit

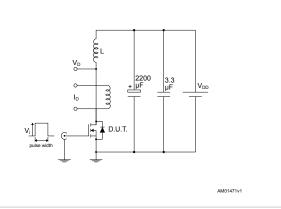


Figure 17. Unclamped inductive waveform

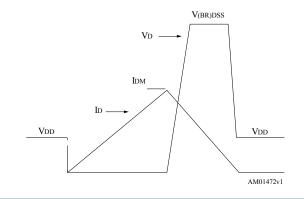
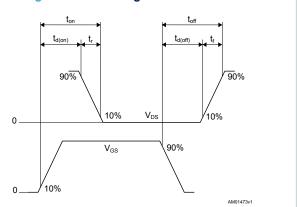


Figure 18. Switching time waveform



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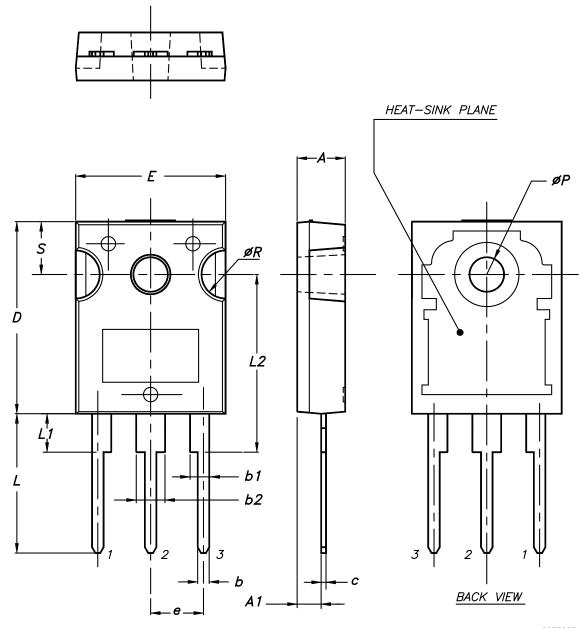


# 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

### 4.1 TO-247 package information

Figure 19. TO-247 package outline



0075325\_9

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Table 8. TO-247 package mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

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# **Revision history**

Table 9. Document revision history

Date	Revision	Changes
09-Jun-2014	1	First release.
		Document status promoted from preliminary to production data.
01-Sep-2014	2	Added Section 2.1: "Electrical characteristics curves".
		Minor text changes.
		Updated Table 1. Absolute maximum ratings, Table 3. Avalanche characteristics,
19-Jan-2017	3	Table 4. On /off-states and Table 6. Switching times.
		Updated Section 2.1 Electrical characteristics (curves).
19-Mar-2020	4	Updated Table 6. Switching times.
	4	Minor text changes.

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